LISTING OF CLAIMS

1. (Previously Presented) A method of forming an underlayer of a bi-layer resist film, comprising:

forming a blended material by blending a polymer having an aromatic group and a methacrylate polymer represented by the following chemical formula:

$$\begin{array}{c|c}
H & R_2 \\
\hline
C & C & m \\
H & O \\
R_1
\end{array}$$

wherein, R₁ is one selected from a group consisting of an aromatic compound, a hydrocarbon of 1 to 5 carbon atoms, an aliphatic hydrocarbon of 1 to 15 carbon atoms, a lactone of 1 to 15 carbon atoms, an ether of 1 to 15 carbon atoms and a carboxylic acid of 1 to 15 carbon atoms, R₂ is a hydrogen or a methyl group, and m is an integer ranging from 10 to 500;

coating a substrate with the blended material; and irradiating the blended material coated on the substrate.

- 2. (Original) The method according to claim 1, wherein the polymer having an aromatic group is a novolac polymer or a naphthalene polymer.
- 3. (Original) The method according to claim 2, wherein the methacrylate polymer is blended to 20 to 70 wt% of a sum of weights of the novolac and the methacrylate polymers.
- 4. (Original) The method according to claim 2, wherein the methacrylate polymer is blended to 20 to 70 wt% of a sum of weights of the naphthalene and the methacrylate polymers.

5. (Original) The method according to claim 1, wherein the blended material futher includes:

at least one selected from a group consisting of a thermal acid generator, a cross-linker and a surfactant.

- 6. (Original) The method according to claims 1, wherein the coated substrate is irradiated with UV rays or an e-beam.
- 7. (Original) The method according to claim 6, wherein the UV rays have a wavelength of about 150 nm to about 180 nm.
- 8. (Original) The method according to claim 7, wherein the UV rays have a wavelength of about 172 nm.
- 9. (Original) The method according to claim 6, wherein the UV rays have energy of about 0.1 J/cm² to about 100 J/cm².
- 10. (Original) The method according to claim 6, wherein the e-beam has energy of about 0.1 mC/cm² to about 100 mC/cm².
- 11. (Original) The method according to claims 1, wherein the coated substrate is irradiated at a temperature of about room temperature to about 100 °C.
- 12. (Original) The method according to claim 11, wherein the temperature at which the coated substrate is irradiated is adjusted using a hot plate or a halogen lamp.

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13. (Previously Presented) A method of forming a underlayer of a bi-layer resist film, comprising:

preparing a material including a copolymer having a monomer with an aromatic group and a methacrylate monomer, the copolymer represented by the following chemical formula:

$$\begin{array}{c|c}
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wherein, R₁ is one selected from a group consisting of an aromatic compound, a hydrocarbon of 1 to 5 carbon atoms, an aliphatic hydrocarbon of 1 to 15 carbon atoms, a lactone of 1 to 15 carbon atoms, an ether of 1 to 15 carbon atoms and a carboxylic acid of 1 to 15 carbon atoms, R₂ is a hydrogen or a methyl group, R₃ is a monomer having an aromatic group, and each of m and n is an integer ranging from 10 to 500;

coating a substrate with the prepared material; and irradiating the prepared material coated on the substrate.

14. (Previously Presented) The method according to claim 13, wherein the copolymer is a copolymer having styrene and methacrylate monomers, the copolymer represented by the following chemical formula:

$$\begin{array}{c|c}
H & H \\
\hline
C & C \\
H & H
\end{array}$$

$$\begin{array}{c|c}
H & R_2 \\
\hline
C & C \\
\hline
M & O
\end{array}$$

$$\begin{array}{c|c}
R_1 \\
\hline
R_3
\end{array}$$

wherein, R1 is one selected from a group consisting of an aromatic compound, a hydrocarbon of 1 to 5 carbon atoms, an aliphatic hydrocarbon of 1 to 15 carbon atoms, a lactone of 1 to 15 carbon atoms, an ether of 1 to 15 carbon atoms and a carboxylic acid of 1 to 15 carbon atoms, R2

is a hydrogen or a methyl group, R₃ is one selected from a group consisting of hydrogen, a hydroxyl group, a chlorine and a bromine, and each of m and n is an integer ranging from 10 to 500.

- 15. (Original) The method according to claim 14, wherein the mole ratio m/(m + n) is about 0.3 to about 0.6.
- 16. (Original) The method according to claim 13, wherein the material including the copolymer further includes:

at least one selected from a group consisting of a thermal acid generator, a cross-linker and a surfactant.

- 17. (Original) The method according to one of claims 13, wherein the coated substrate is irradiated with UV rays or an e-beam.
- 18. (Original) The method according to claim 17, wherein the UV rays have a wavelength of about 150 nm to about 180 nm.
- 19. (Original) The method according to claim 18, wherein the UV rays have a wavelength of about 172 nm.
- 20. (Original) The method according to claim 17, wherein the UV rays have energy of about 0.1 J/cm² to about 100 J/cm².
- 21. (Original) The method according to claim 17, wherein the e-beam has energy of about 0.1 mC/cm² to about 100 mC/cm².

- 22. (Original) The method according to claim 13, wherein the irradiation of coated substrate is performed at a temperature of about room temp. to about 100 °C.
- 23. (Original) The method according to claim 22, wherein the temperature at which the coated substrate is irradiated is adjusted using a hot plate or a halogen lamp.
- 24. (Previously Presented) A method of forming a semiconductor device using a bilayer resist, comprising:

forming a blended material by blending a polymer having an aromatic group and a methacrylate polymer represented by the following chemical formula:

$$\begin{array}{c|c}
H & R_2 \\
C & C
\end{array}$$

$$\begin{array}{c|c}
m \\
R_1
\end{array}$$

wherein, R₁ is one selected from a group consisting of an aromatic compound, a hydrocarbon of 1 to 5 carbon atoms, an aliphatic hydrocarbon of 1 to 15 carbon atoms, a lactone of 1 to 15 carbon atoms, an ether of 1 to 15 carbon atoms and a carboxylic acid of 1 to 15 carbon atoms, R₂ is a hydrogen or a methyl group, and m is an integer ranging from 10 to 500;

coating a substrate with the blended material;

forming an underlayer by irradiating the blended material coated on the substrate;

forming a toplayer over the underlayer;

forming a toplayer pattern in the toplayer;

forming an underlayer pattern by etching the underlayer using the toplayer pattern as an etch mask; and

etching the substrate using the underlayer pattern as an etch mask.

- 25. (Original) The method of claim 24, further comprising: performing a first prebake after coating the substrate with the blended material.
- 26. (Original) The method of claim 25, further comprising: performing a second prebake after forming a toplayer over the underlayer.
- 27. (Original) The method of claim 24, further comprising: removing the toplayer and the underlayer after etching the substrate.
- 28. (Original) The method of claim 27, wherein the toplayer and the underlayer are removed by ashing.
- 29. (Previously Presented) A method of forming a semiconductor device using a bilayer resist, comprising:

preparing a material including a copolymer having a monomer with an aromatic group and a methacrylate monomer, the copolymer represented by the following chemical formula:

$$\begin{array}{c|c}
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wherein, R₁ is one selected from a group consisting of an aromatic compound, a hydrocarbon of 1 to 5 carbon atoms, an aliphatic hydrocarbon of 1 to 15 carbon atoms, a lactone of 1 to 15 carbon atoms, an ether of 1 to 15 carbon atoms and a carboxylic acid of 1 to 15 carbon atoms, R₂ is a hydrogen or a methyl group, R₃ is a monomer having an aromatic group, and each of m and n is an integer ranging from 10 to 500;

coating a substrate with the prepared material;

forming an underlayer by irradiating the prepared material coated on the substrate;

forming a toplayer over the underlayer;

forming a toplayer pattern in the toplayer;

forming an underlayer pattern by etching the underlayer using the toplayer pattern as an etch mask; and

etching the substrate using the underlayer pattern as an etch mask.

- 30. (Original) The method of claim 29, further comprising:

 performing a first prebake after coating the substrate with the prepared material.
- 31. (Original) The method of claim 30, further comprising: performing a second prebake after forming a toplayer over the underlayer.
- 32. (Original) The method of claim 29, further comprising: removing the toplayer and the underlayer after etching the substrate.
- 33. (Original) The method of claim 32, wherein the toplayer and the underlayer are removed by ashing.